

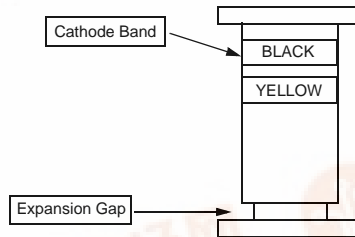


FDLL4151

Small Signal Diode

General Description

A general purpose diode that couples high forward conductance fast switching speed and high blocking voltages in a glass leadless LL-34 surface mount package. Placement of the expansion gap has no relationship to the location of the cathode terminal which is indicated by the first color band.



Absolute Maximum Ratings * T_a = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V _{RRM}	Maximum Repetitive Reverse Voltage	75	V
I _{F(AV)}	Average Rectified Forward Current	200	mA
I _{F(SM)}	Non-repetitive Peak Forward Current Pulse Width = 1.0 second Pulse Width = 1.0microsecond	1.0	A
		4.0	A
T _{STG}	Storage Temperature Range	-65 to +200	°C
T _J	Operating Junction Temperature	-65 to +200	°C

* These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

NOTES:

1. These ratings are based on a maximum junction temperature of 200 degrees C.
2. These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

Symbol	Parameter	Value	Units
P _D	Power Dissipation	500	mW
R _{θJA}	Thermal Resistance, Junction to Ambient	350	°C/W

Electrical Characteristics T_C = 25°C unless otherwise noted

Symbol	Parameter	Conditions	Min.	Max	Units
V _R	Breakdown Voltage	I _R = 5μA	75		V
V _F	Forward Voltage	I _F = 50mA		1	V
I _R	Reverse Current	V _R = 50V		50	nA
		V _R = 30V, T _A = 150°C		50	μA
C _T	Total Capacitance	V _R = 0, f = 1.0MHz		4	pF
t _{rr1}	Reverse Recovery Time	I _F = I _R = 10mA, I _{RR} = 1mA R _L = 100Ω		4	ns
		V _R = 6V, I _F = 10mA, I _{RR} = 1mA R _L = 100Ω		2	ns



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